Vincotech

V23990-P544-A29-PM
datasheet

***flow*PIM 0** **600 V / 15 A**

Topology features
- Open Emitter configuration
- Temperature sensor
- Converter+Brake+Inverter

Component features
- Easy paralleling
- Low turn-off losses
- Low collector emitter saturation voltage
- Positive temperature coefficient
- Short tail current

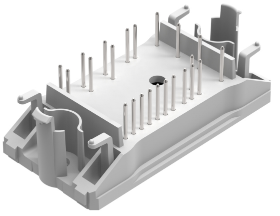
Housing features
- Base isolation: Al_2O_3
- Clip-in, reliable mechanical connection, qualified for wave soldering
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Solder pin

Extra features
- full configuration

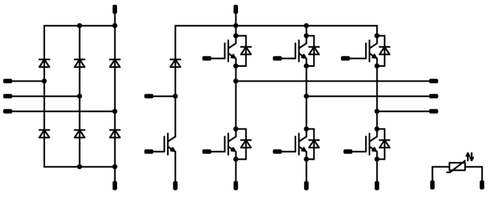
Target applications
- Industrial drives
- Embedded drives

Types
- V23990-P544-A29-PM

flow 0 17 mm housing



Schematic



Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions		Value	Unit
Inverter Switch					
Collector-emitter voltage	V_{CES}			600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$	T_s = 80 °C	22	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}		45	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	52	W
Gate-emitter voltage	V_{GES}			±20	V
Short circuit ratings	t_{SC}	V_{GE} = 15 V, V_{CC} = 360 V	T_j = 150 °C	6	µs
Maximum junction temperature	T_{jmax}			175	°C
Inverter Diode					
Peak repetitive reverse voltage	V_{RRM}			600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	T_s = 80 °C	20	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}		30	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	38	W
Maximum junction temperature	T_{jmax}			175	°C
Brake Switch					
Collector-emitter voltage	V_{CES}			600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$	T_s = 80 °C	16	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}		30	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	44	W
Gate-emitter voltage	V_{GES}			±20	V
Short circuit ratings	t_{SC}	V_{GE} = 15 V, V_{CC} = 360 V	T_j = 150 °C	6	µs
Maximum junction temperature	T_{jmax}			175	°C

Maximum Ratings

T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions		Value	Unit
Brake Diode					
Peak repetitive reverse voltage	V_{RRM}			600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	T_s = 80 °C	16	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}		20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	32	W
Maximum junction temperature	T_{jmax}			175	°C
Rectifier Diode					
Peak repetitive reverse voltage	V_{RRM}			1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$	T_s = 80 °C	34	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, t_p = 10 ms	T_j = 150 °C	200	A
Surge current capability	I^2t			200	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$	T_s = 80 °C	44	W
Maximum junction temperature	T_{jmax}			150	°C
Module Properties					
Thermal Properties					
Storage temperature	T_{stg}			-40…+125	°C
Operation temperature under switching condition	T_{jop}			-40…+(T_{jmax} - 25)	°C
Isolation Properties					
Isolation voltage	V_{isol}	DC Test Voltage*	t_p = 2 s	6000	V
Isolation voltage	V_{isol}	AC Voltage	t_p = 1 min	2500	V
Creepage distance				>12,7	mm
Clearance				>12,7	mm
Comparative Tracking Index	CTI			≥ 200	

*100 % tested in production

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Inverter Switch										
Static										
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00021	25	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CEsat}		15		15	25 125	1,1	1,61 1,81	1,9(1)	V
Collector-emitter cut-off current	I_{CES}		0	600		25			0,85	µA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	f = 1 Mhz	0	25		25		800		pF
Output capacitance	C_{oes}							55		pF
Reverse transfer capacitance	C_{res}							24		pF
Gate charge	Q_g		0/15		0	25		87		nC
Thermal										
Thermal resistance junction to sink (2)	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,83		K/W
Dynamic										
Turn-on delay time	$t_{d(on)}$	R_{gon} = 16 Ω R_{goff} = 8 Ω	±15	300	15	25 125 150		65,92 65,76 65,6		ns
Rise time	t_r					25 125 150		25,92 27,36 28,16		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		82,08 97,28 99,84		ns
Fall time	t_f					25 125 150		70,77 77,18 77,64		ns
Turn-on energy (per pulse)	E_{on}	Q_{rFWD}=0,497 µC Q_{rFWD}=1 µC Q_{rFWD}=1,17 µC				25 125 150		0,21 0,298 0,329		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,282 0,376 0,402		mWs

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Inverter Diode										
Static										
Forward voltage	V_F				15	25 125	1,25	1,79 1,67	1,95[1]	V
Reverse leakage current	I_R	V_r = 600 V				25			27	µA
Thermal										
Thermal resistance junction to sink [2]	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						2,51		K/W
Dynamic										
Peak recovery current	I_{RRM}					25 125 150		6,34 8,78 9,51		A
Reverse recovery time	t_{rr}					25 125 150		214,72 282,23 311,18		ns
Recovered charge	Q_r	d*i*/d*t*=553 A/µs d*i*/d*t*=520 A/µs d*i*/d*t*=524 A/µs	±15	300	15	25 125 150		0,497 1 1,17		µC
Reverse recovered energy	E_{rec}					25 125 150		0,115 0,23 0,268		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		52,38 63,68 63,26		A/µs

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Brake Switch										
Static										
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00015	25	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CEsat}		15		10	25 125	1,1	1,66 1,87	1,9(1)	V
Collector-emitter cut-off current	I_{CES}		0	600		25			0,6	µA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	f = 1 Mhz	0	25		25		551		pF
Output capacitance	C_{oes}							40		pF
Reverse transfer capacitance	C_{res}							17		pF
Thermal										
Thermal resistance junction to sink (2)	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						2,15		K/W
Dynamic										
Turn-on delay time	$t_{d(on)}$	R_{gon} = 32 Ω R_{goff} = 16 Ω	0/15	300	10	25 125 150		34,08 31,68 31,04		ns
Rise time	t_r					25 125 150		28,64 31,2 32		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		133,28 150,08 153,76		ns
Fall time	t_f					25 125 150		96,72 97,35 100,84		ns
Turn-on energy (per pulse)	E_{on}	Q_{rFWD}=0,344 µC Q_{rFWD}=0,678 µC Q_{rFWD}=0,788 µC				25 125 150		0,169 0,236 0,254		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,23 0,298 0,316		mWs

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Brake Diode										
Static										
Forward voltage	V_F				10	25 125	1,25	1,68 1,61	1,95(1)	V
Reverse leakage current	I_R	V_r = 600 V				25			27	µA
Thermal										
Thermal resistance junction to sink (2)	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						2,99		K/W
Dynamic										
Peak recovery current	I_{RRM}	di/dt=316 A/µs di/dt=289 A/µs di/dt=298 A/µs	0/15	300	10	25 125 150		3,82 5,68 6,14		A
Reverse recovery time	t_{rr}					25 125 150		222,64 283,44 313,89		ns
Recovered charge	Q_r					25 125 150		0,344 0,678 0,788		µC
Reverse recovered energy	E_{rec}					25 125 150		0,078 0,151 0,176		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		26,24 42,8 40,68		A/µs

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	
Rectifier Diode										
Static										
Forward voltage	V_F				8	25 125		0,983 0,889	1,21[1] 1,1[1]	V
Reverse leakage current	I_R	V_r = 1600 V				25			50	µA
Thermal										
Thermal resistance junction to sink [2]	$R_{th(j-s)}$	λ_{paste} = 3,4 W/mK (PSX)						1,59		K/W
Thermistor										
Static										
Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$\Delta_{R/R}$	R_{100} = 1484 Ω				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

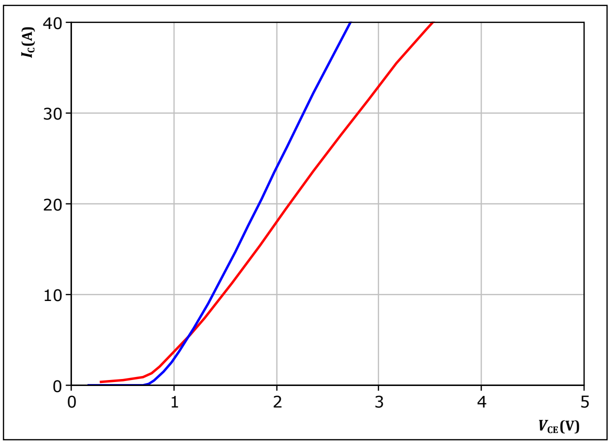
[1] Value at chip level
[2] Only valid with pre-applied Vincotech thermal interface material.

Inverter Switch Characteristics

figure 1. **IGBT**

Typical output characteristics

I_C = f(V_{CE})



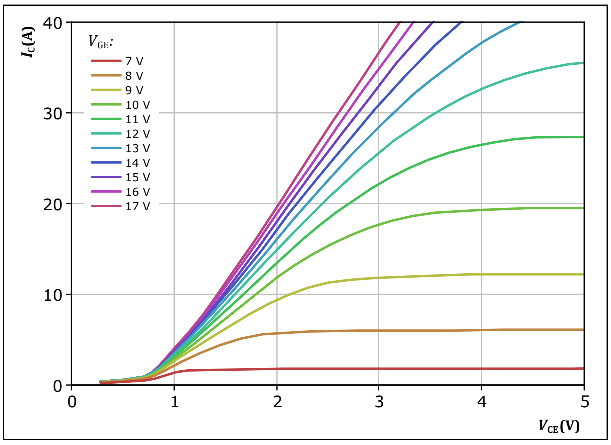
t_p = 250 µs
V_{GE} = 15 V

T_j: 25 °C, 125 °C

figure 2. **IGBT**

Typical output characteristics

I_C = f(V_{CE})

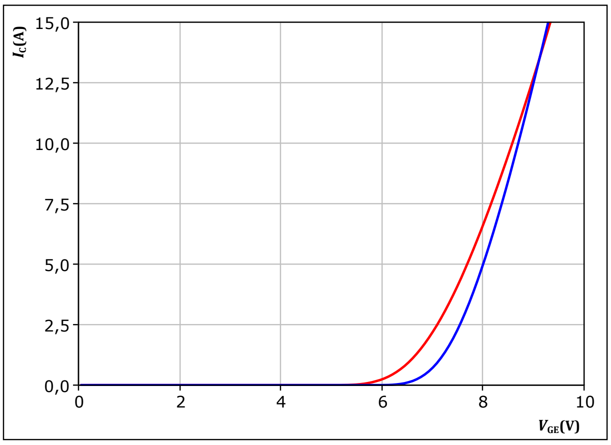


t_p = 250 µs
T_j = 125 °C
V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. **IGBT**

Typical transfer characteristics

I_C = f(V_{GE})



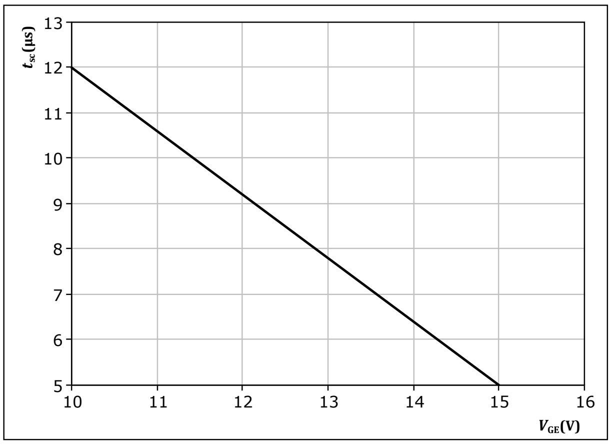
t_p = 250 µs
V_{CE} = 10 V

T_j: 25 °C, 125 °C

figure 4. **IGBT**

Short circuit withstand time as a function of V_{GE}

t_{sc} = f(V_{GE})



At V_{CE} = 600 V
$T_j \leq$ 25 °C

Inverter Switch Characteristics

figure 5. **IGBT**

Typical short circuit current as a function of V_{GE}

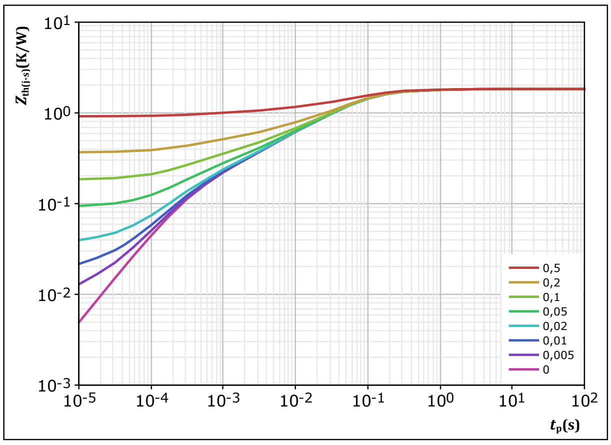
I_{SC} = f(V_{GE})

At	V_{CE} =	400	V
	T_j ≤	150	°C

figure 6. **IGBT**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)}$ = f(t_p)



D = t_p / T

$R_{th(j-s)}$ = 1,834 K/W

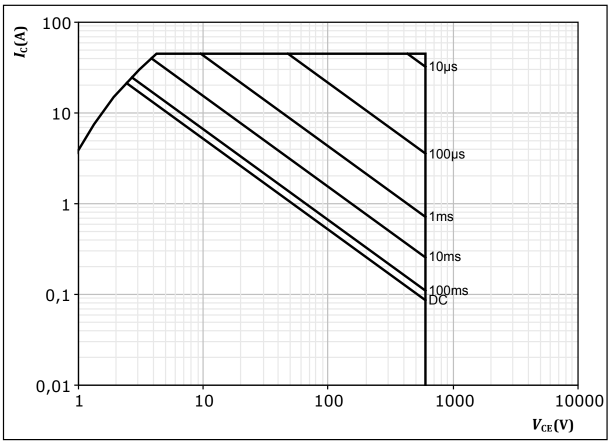
IGBT thermal model values

R (K/W)	τ (s)
8,30E-02	1,29E+00
3,76E-01	1,56E-01
8,46E-01	5,15E-02
2,81E-01	8,16E-03
1,16E-01	2,04E-03
1,32E-01	3,43E-04

figure 7. **IGBT**

Safe operating area

I_C = f(V_{CE})

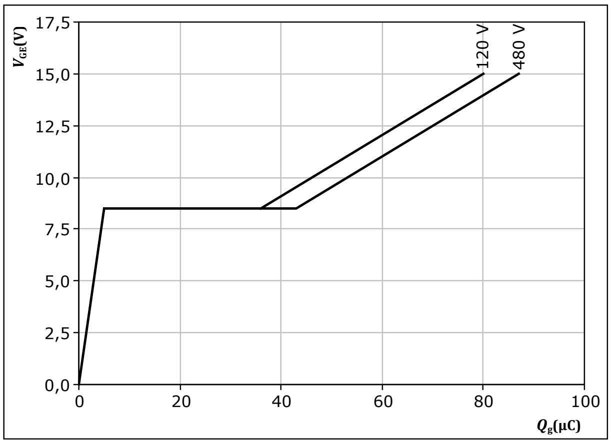


D =	single pulse	
T_s =	80	°C
V_{GE} =	15	V
T_j =	T_{jmax}	

figure 8. **IGBT**

Gate voltage vs gate charge

V_{GE} = f(Q_g)



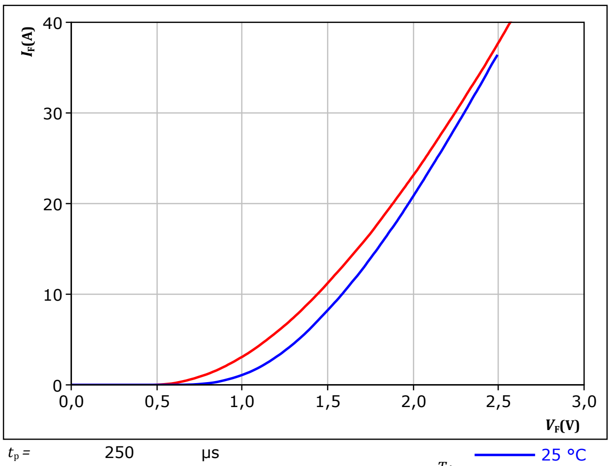
I_C =	15	A
T_j =	25	°C

Inverter Diode Characteristics

figure 9. **FWD**

Typical forward characteristics

$I_F = f(V_F)$



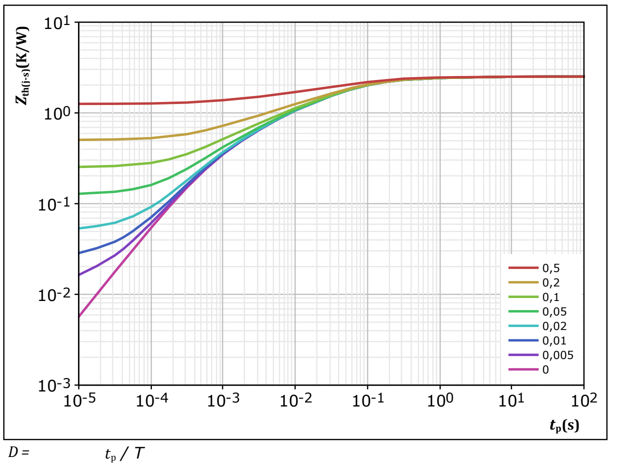
t_p = 250 µs

T_j: 25 °C, 125 °C

figure 10. **FWD**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$

$R_{th(j-s)}$ = 2,513 K/W

FWD thermal model values

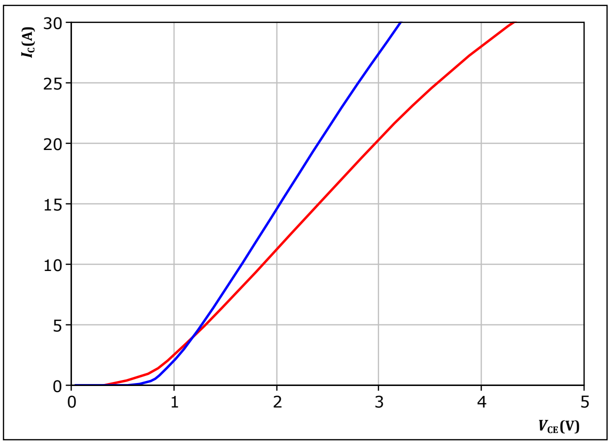
R (K/W)	τ (s)
9,70E-02	3,90E+00
2,83E-01	3,08E-01
8,79E-01	6,57E-02
5,75E-01	1,54E-02
4,51E-01	3,41E-03
2,27E-01	5,87E-04

Brake Switch Characteristics

figure 11.	**IGBT**

Typical output characteristics

I_C = f(V_{CE})

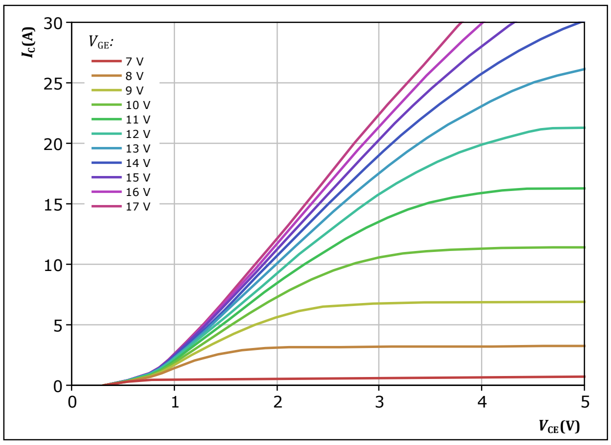


t_p =	250	µs	T_j: 25 °C
V_{GE} =	15	V	125 °C

figure 12.	**IGBT**

Typical output characteristics

I_C = f(V_{CE})



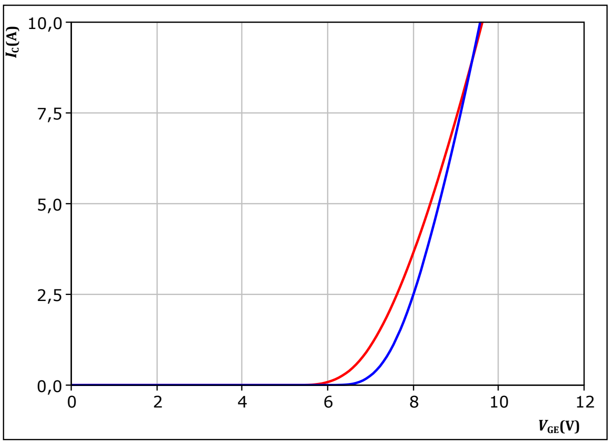
t_p =	250	µs
T_j =	125	°C

V_{GE} from 7 V to 17 V in steps of 1 V

figure 13.	**IGBT**

Typical transfer characteristics

I_C = f(V_{GE})

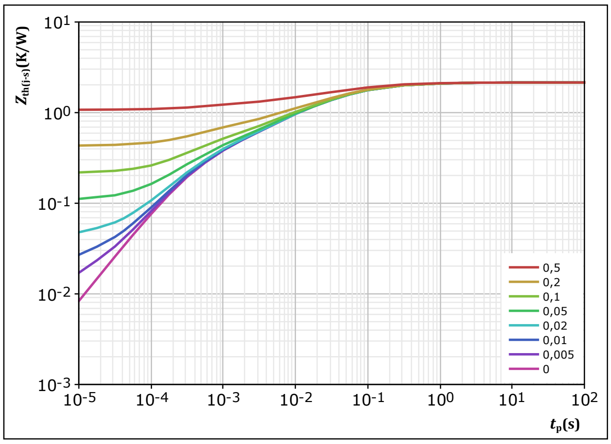


t_p =	250	µs	T_j: 25 °C
V_{CE} =	10	V	125 °C

figure 14.	**IGBT**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)}$ = f(t_p)



D =	t_p / T	
$R_{th(j-s)}$ =	2,149	K/W

IGBT thermal model values

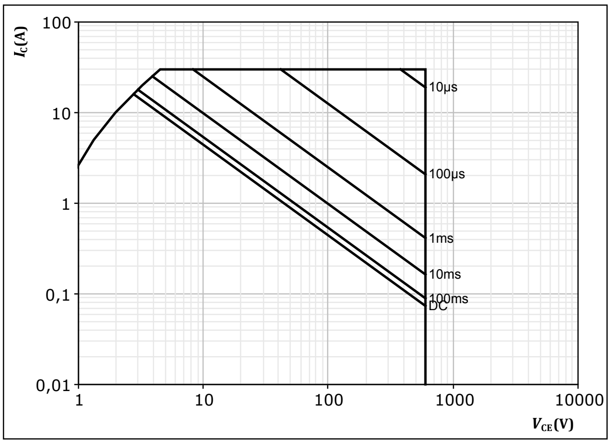
R (K/W)	τ (s)
1,04E-01	1,37E+00
2,88E-01	2,01E-01
6,99E-01	5,27E-02
4,91E-01	1,22E-02
3,07E-01	2,97E-03
2,60E-01	3,80E-04

Brake Switch Characteristics

figure 15. **IGBT**

Safe operating area

$I_C = f(V_{CE})$



D = single pulse

T_s = 80 °C

V_{GE} = 15 V

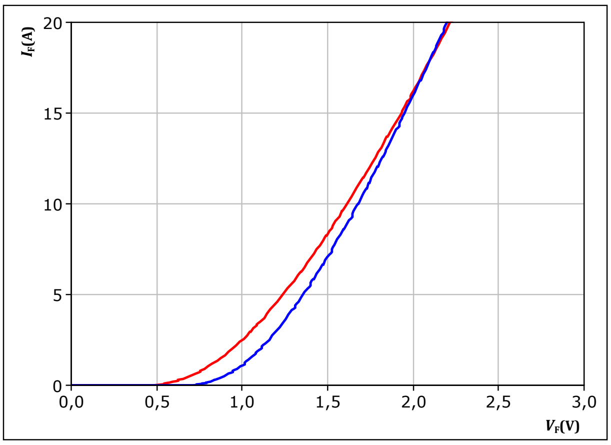
T_j = T_{jmax}

Brake Diode Characteristics

figure 16. **FWD**

Typical forward characteristics

$I_F = f(V_F)$



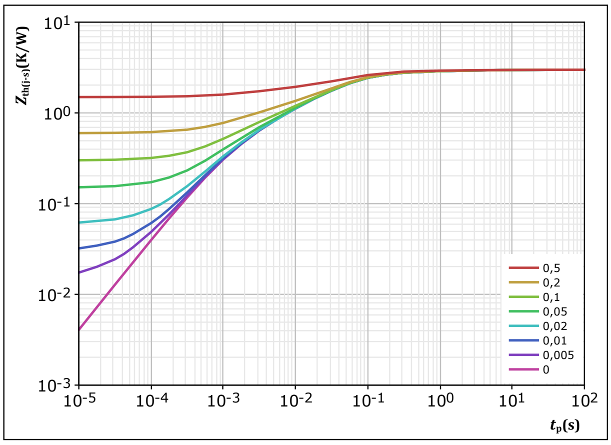
t_p = 250 µs

T_j: 25 °C, 125 °C

figure 17. **FWD**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



$D = t_p / T$

$R_{th(j-s)}$ = 2,988 K/W

FWD thermal model values

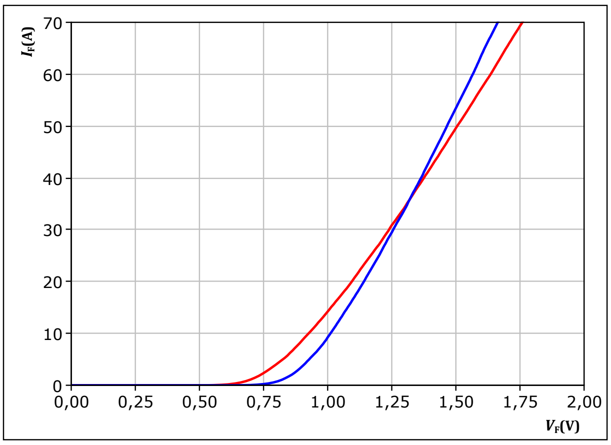
R (K/W)	τ (s)
8,74E-02	5,59E+00
2,41E-01	4,60E-01
1,22E+00	6,53E-02
6,89E-01	2,20E-02
4,52E-01	5,14E-03
2,99E-01	1,11E-03

Rectifier Diode Characteristics

figure 18. **Rectifier**

Typical forward characteristics

$I_F = f(V_F)$



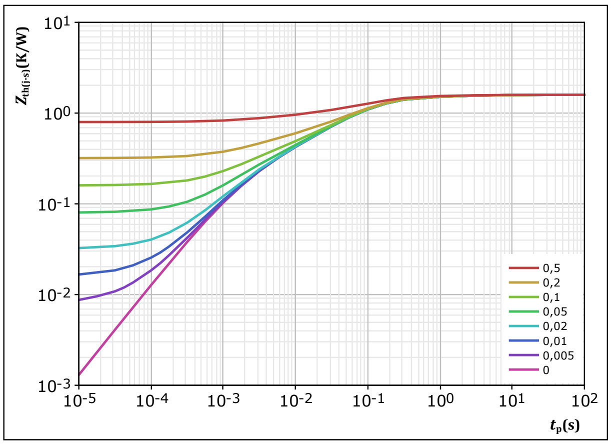
t_p = 250 µs

T_j: 25 °C, 125 °C

figure 19. **Rectifier**

Transient thermal impedance as a function of pulse width

$Z_{th(j-s)} = f(t_p)$



D = t_p / T

$R_{th(j-s)}$ = 1,594 K/W

Rectifier thermal model values

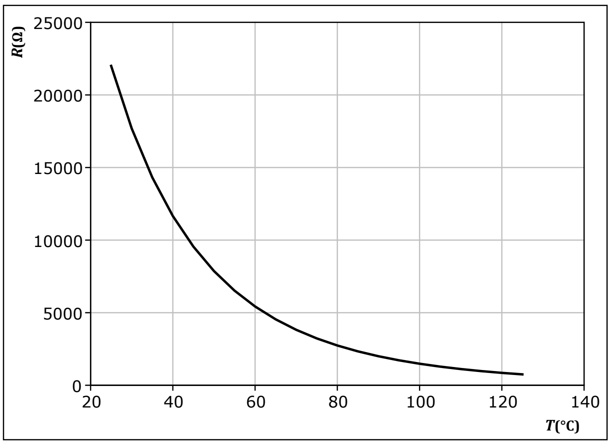
R (K/W)	τ (s)
3,44E-02	9,66E+00
1,12E-01	1,22E+00
5,81E-01	1,45E-01
4,89E-01	5,05E-02
2,38E-01	9,26E-03
1,22E-01	1,79E-03
1,81E-02	7,88E-04

Thermistor Characteristics

figure 20.	Thermistor

Typical NTC characteristic as function of temperature

R_T = f(T)

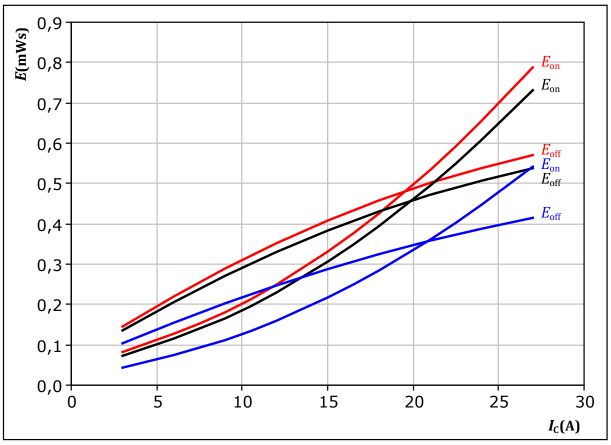


Inverter Switching Characteristics

figure 21. **IGBT**

Typical switching energy losses as a function of collector current

$E = f(I_C)$



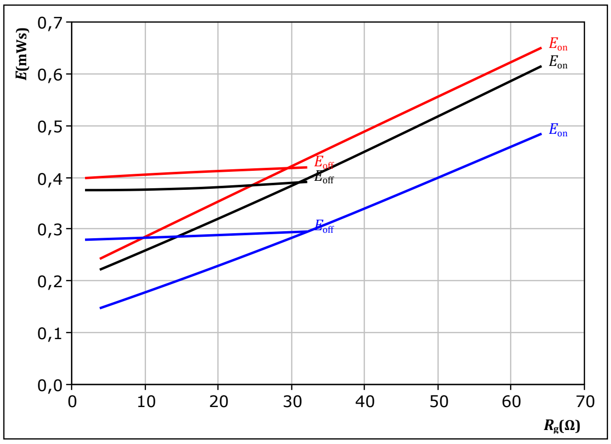
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
R_{gon} =	16	Ω		150 °C
R_{goff} =	8	Ω		

figure 22. **IGBT**

Typical switching energy losses as a function of IGBT turn on gate resistor

$E = f(R_g)$



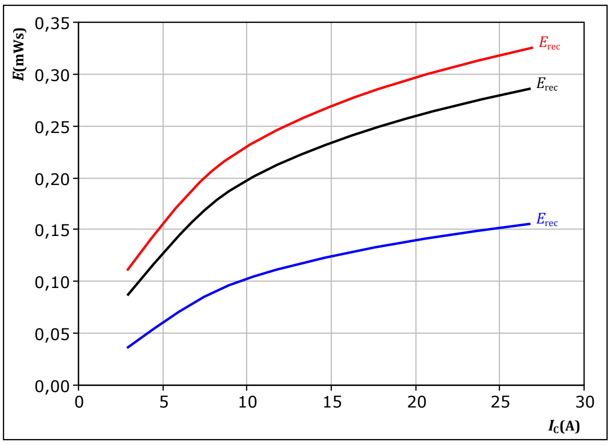
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
I_C =	15	A		150 °C

figure 23. **FWD**

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_C)$



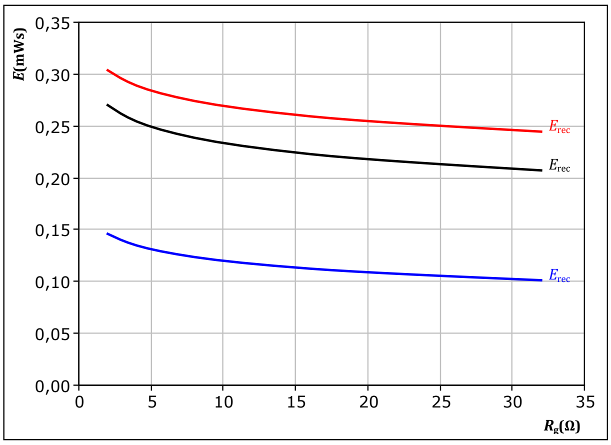
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
R_{gon} =	16	Ω		150 °C

figure 24. **FWD**

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

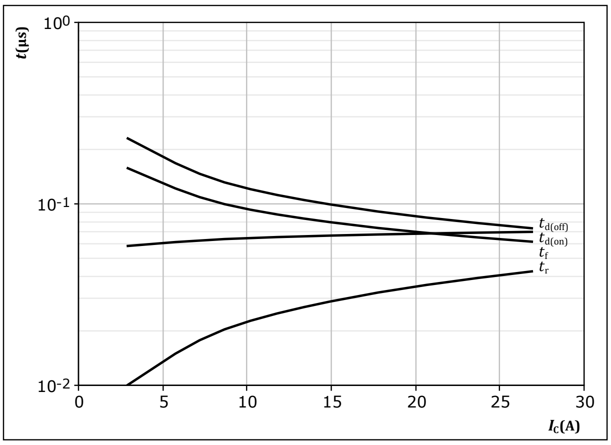
V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
I_C =	15	A		150 °C

Inverter Switching Characteristics

figure 25. **IGBT**

Typical switching times as a function of collector current

$t = f(I_C)$



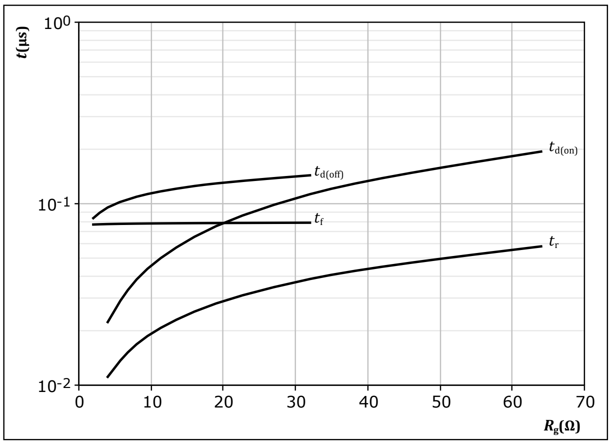
With an inductive load at

T_j =	150	°C
V_{CE} =	300	V
V_{GE} =	±15	V
R_{gon} =	16	Ω
R_{goff} =	8	Ω

figure 26. **IGBT**

Typical switching times as a function of IGBT turn on gate resistor

$t = f(R_g)$



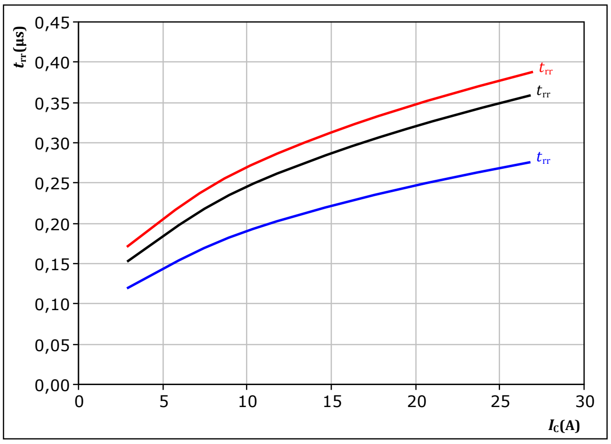
With an inductive load at

T_j =	150	°C
V_{CE} =	300	V
V_{GE} =	±15	V
I_C =	15	A

figure 27. **FWD**

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



With an inductive load at

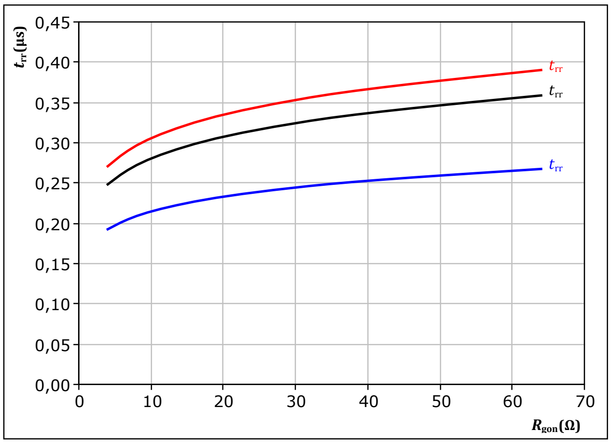
V_{CE} =	300	V
V_{GE} =	±15	V
R_{gon} =	16	Ω

T_j: 25 °C, 125 °C, 150 °C

figure 28. **FWD**

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



With an inductive load at

V_{CE} =	300	V
V_{GE} =	±15	V
I_C =	15	A

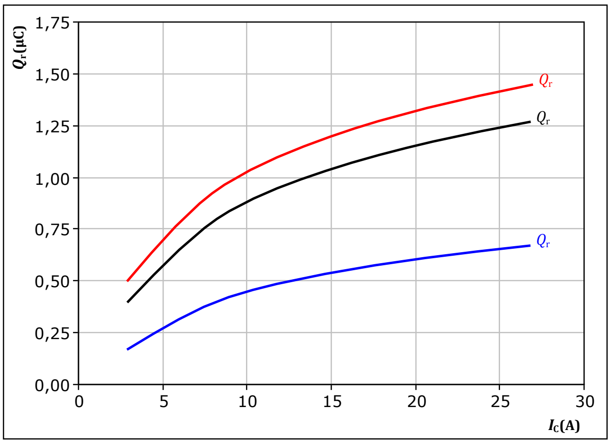
T_j: 25 °C, 125 °C, 150 °C

Inverter Switching Characteristics

figure 29. **FWD**

Typical recovered charge as a function of collector current

Q_r = f(I_C)



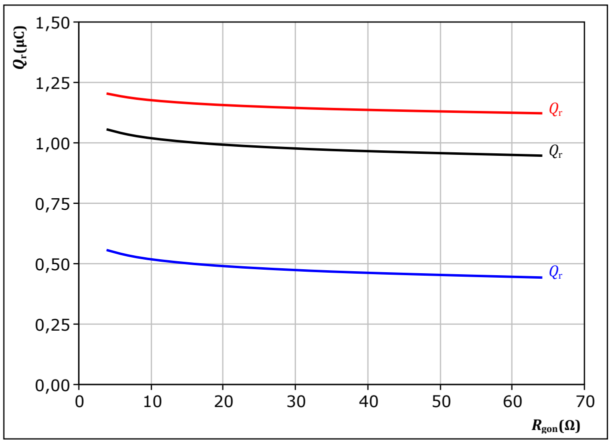
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
R_{gon} =	16	Ω		150 °C

figure 30. **FWD**

Typical recovered charge as a function of IGBT turn on gate resistor

Q_r = f(R_{gon})



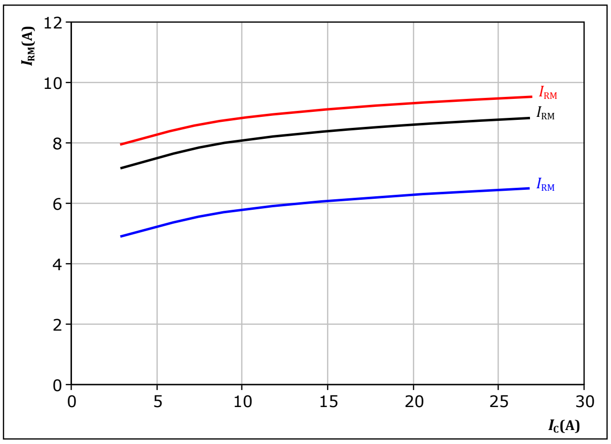
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
I_C =	15	A		150 °C

figure 31. **FWD**

Typical peak reverse recovery current as a function of collector current

I_{RM} = f(I_C)



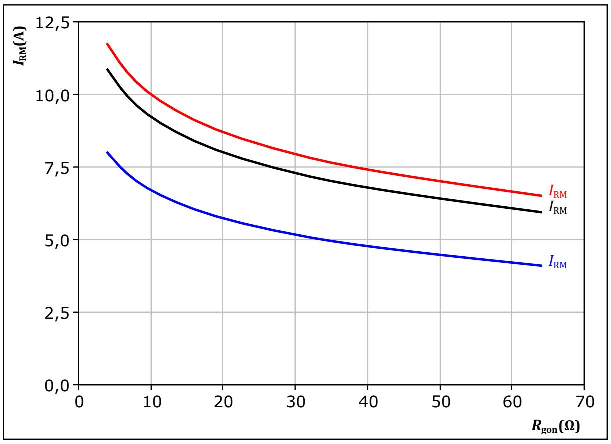
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
R_{gon} =	16	Ω		150 °C

figure 32. **FWD**

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

I_{RM} = f(R_{gon})



With an inductive load at

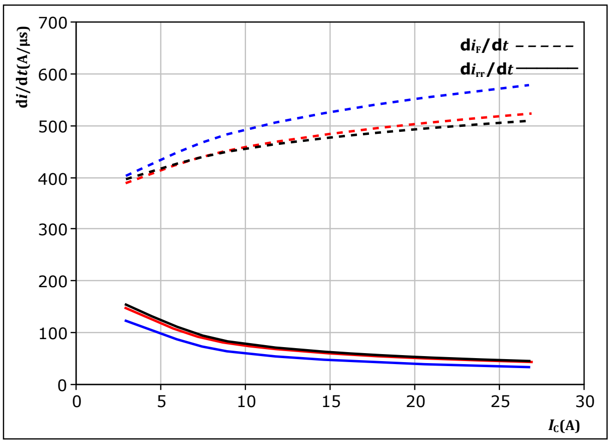
V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
I_C =	15	A		150 °C

Inverter Switching Characteristics

figure 33. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of collector current

di_F/dt, di_{rr}/dt = f(I_C)



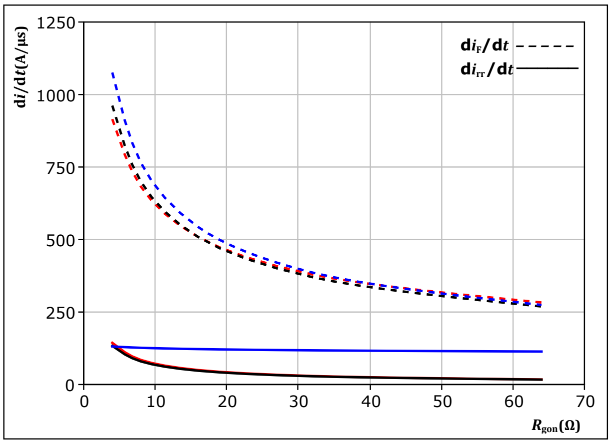
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
R_{gon} =	16	Ω		150 °C

figure 34. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

di_F/dt, di_{rr}/dt = f(R_{gon})



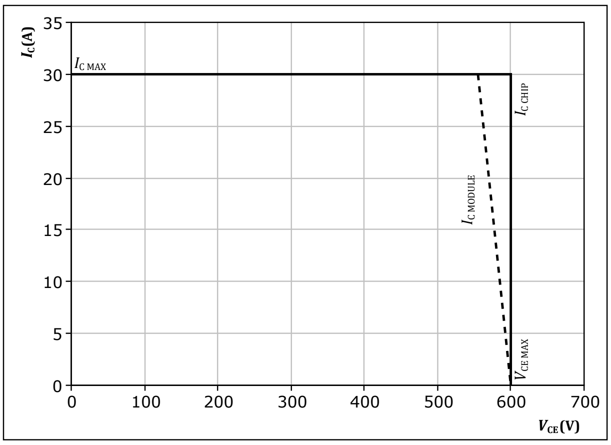
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	±15	V		125 °C
I_C =	15	A		150 °C

figure 35. **IGBT**

Reverse bias safe operating area

I_C = f(V_{CE})



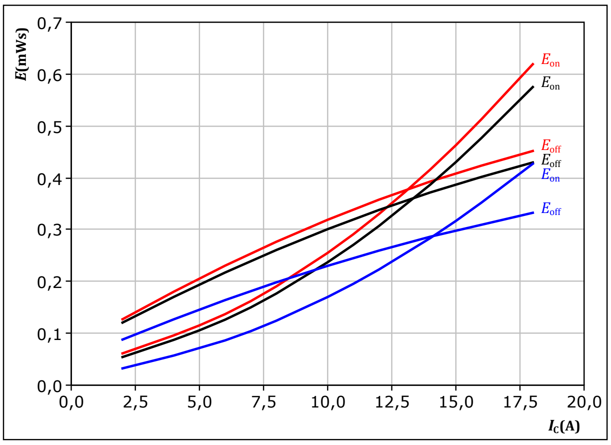
At	T_j =	150	°C
	R_{gon} =	16	Ω
	R_{goff} =	8	Ω

Brake Switching Characteristics

figure 36. **IGBT**

Typical switching energy losses as a function of collector current

$E = f(I_C)$



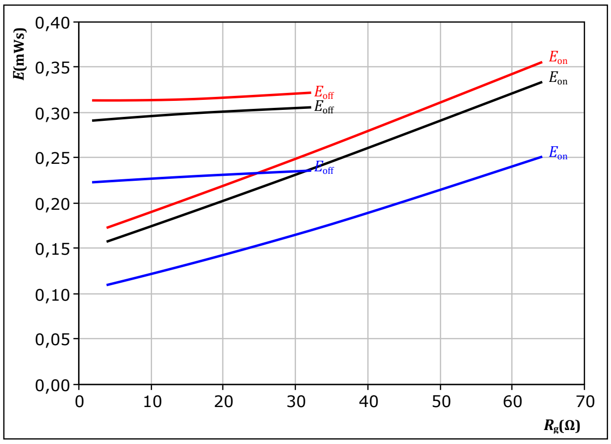
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
R_{gon} =	32	Ω		150 °C
R_{goff} =	16	Ω		

figure 37. **IGBT**

Typical switching energy losses as a function of IGBT turn on gate resistor

$E = f(R_g)$



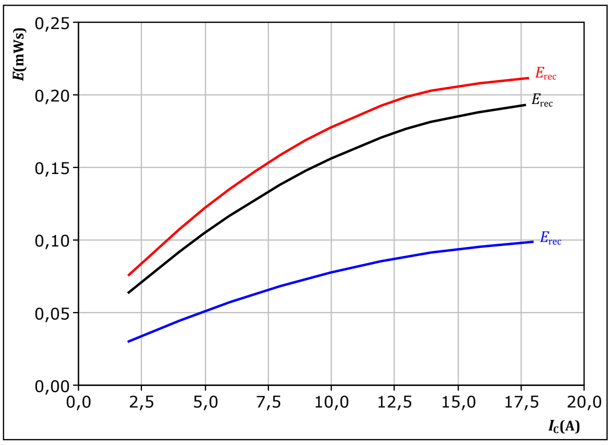
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
I_C =	10	A		150 °C

figure 38. **FWD**

Typical reverse recovered energy loss as a function of collector current

$E_{rec} = f(I_C)$



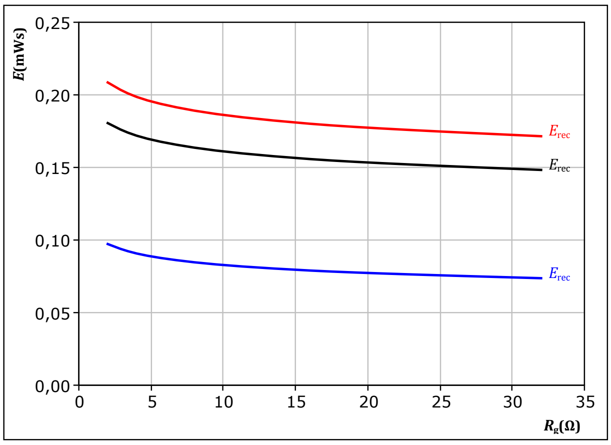
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
R_{gon} =	32	Ω		150 °C

figure 39. **FWD**

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$E_{rec} = f(R_g)$



With an inductive load at

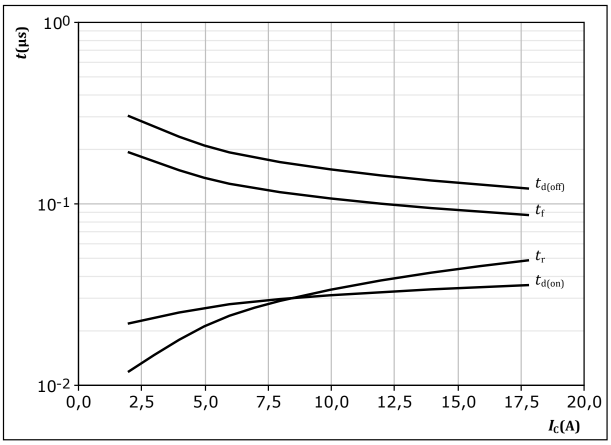
V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
I_C =	10	A		150 °C

Brake Switching Characteristics

figure 40. **IGBT**

Typical switching times as a function of collector current

t = f(I_C)



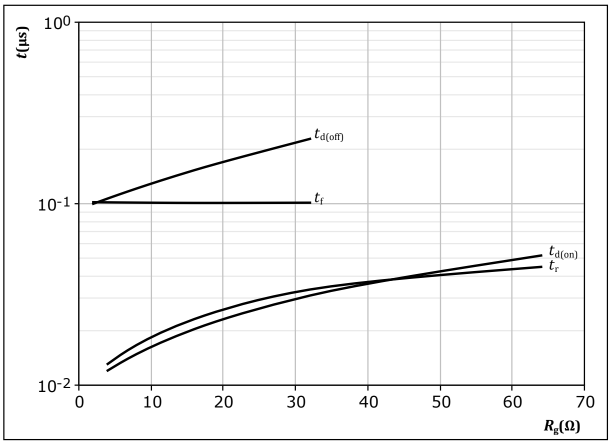
With an inductive load at

T_j =	150	°C
V_{CE} =	300	V
V_{GE} =	0/15	V
R_{gon} =	32	Ω
R_{goff} =	16	Ω

figure 41. **IGBT**

Typical switching times as a function of IGBT turn on gate resistor

t = f(R_g)



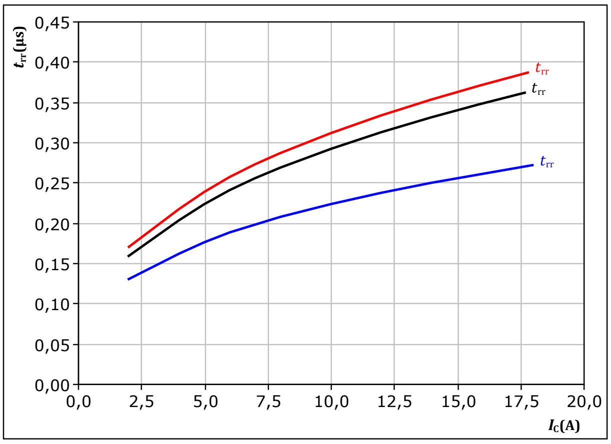
With an inductive load at

T_j =	150	°C
V_{CE} =	300	V
V_{GE} =	0/15	V
I_C =	10	A

figure 42. **FWD**

Typical reverse recovery time as a function of collector current

t_{rr} = f(I_C)



With an inductive load at

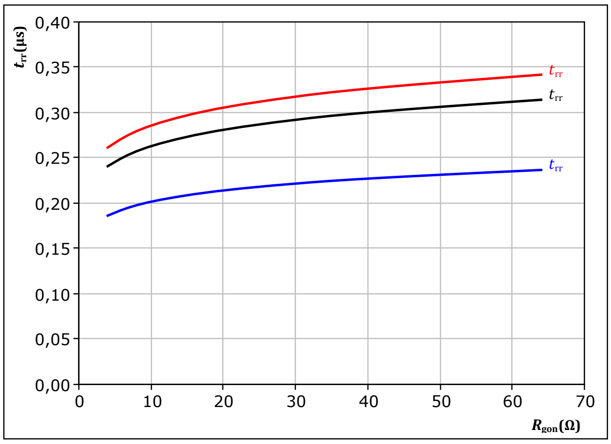
V_{CE} =	300	V
V_{GE} =	0/15	V
R_{gon} =	32	Ω

T_j: 25 °C, 125 °C, 150 °C

figure 43. **FWD**

Typical reverse recovery time as a function of IGBT turn on gate resistor

t_{rr} = f(R_{gon})



With an inductive load at

V_{CE} =	300	V
V_{GE} =	0/15	V
I_C =	10	A

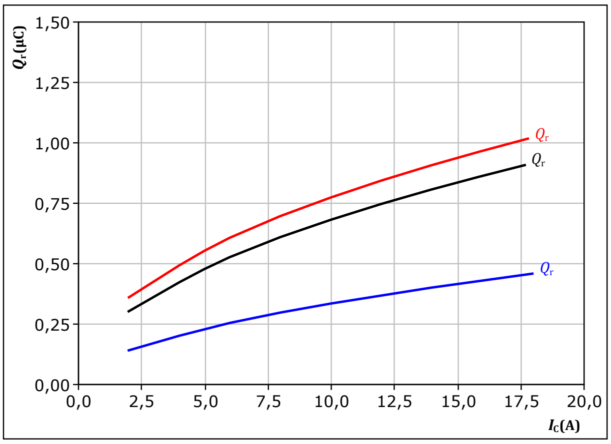
T_j: 25 °C, 125 °C, 150 °C

Brake Switching Characteristics

figure 44. FWD

Typical recovered charge as a function of collector current

Q_r = f(I_C)



With an inductive load at

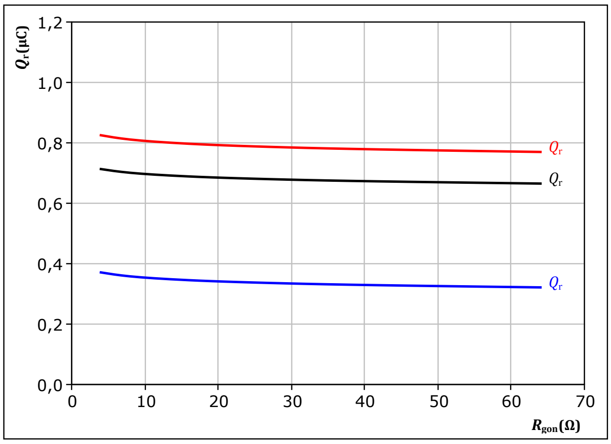
V_{CE} = 300 V
V_{GE} = 0/15 V
R_{gon} = 32 Ω

T_j: 25 °C, 125 °C, 150 °C

figure 45. FWD

Typical recovered charge as a function of IGBT turn on gate resistor

Q_r = f(R_{gon})



With an inductive load at

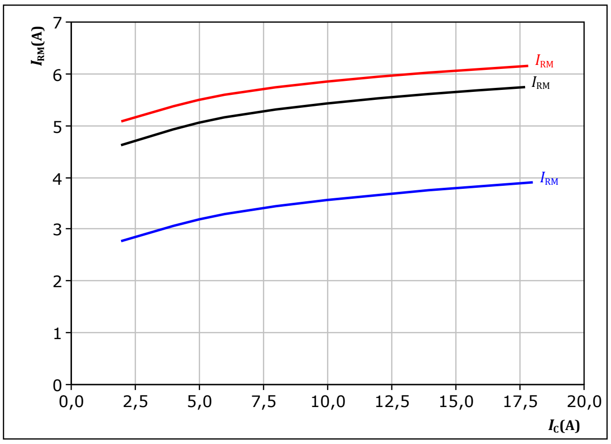
V_{CE} = 300 V
V_{GE} = 0/15 V
I_C = 10 A

T_j: 25 °C, 125 °C, 150 °C

figure 46. FWD

Typical peak reverse recovery current as a function of collector current

I_{RM} = f(I_C)



With an inductive load at

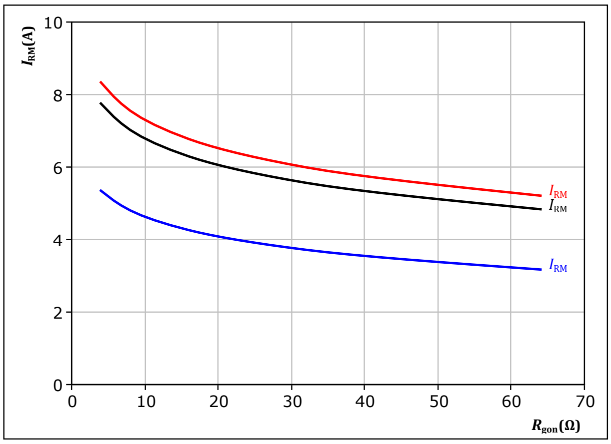
V_{CE} = 300 V
V_{GE} = 0/15 V
R_{gon} = 32 Ω

T_j: 25 °C, 125 °C, 150 °C

figure 47. FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

I_{RM} = f(R_{gon})



With an inductive load at

V_{CE} = 300 V
V_{GE} = 0/15 V
I_C = 10 A

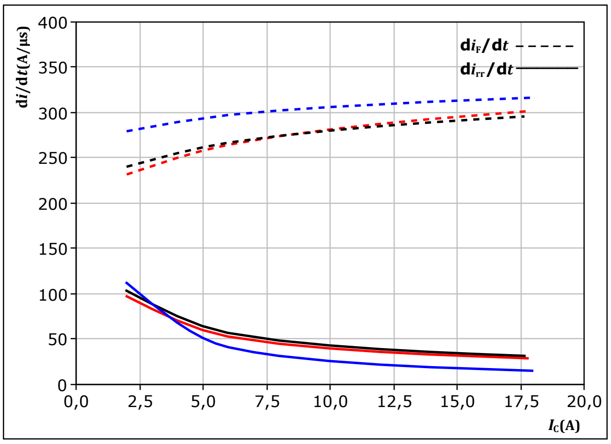
T_j: 25 °C, 125 °C, 150 °C

Brake Switching Characteristics

figure 48. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of collector current

di_F/dt, di_{rr}/dt = f(I_C)



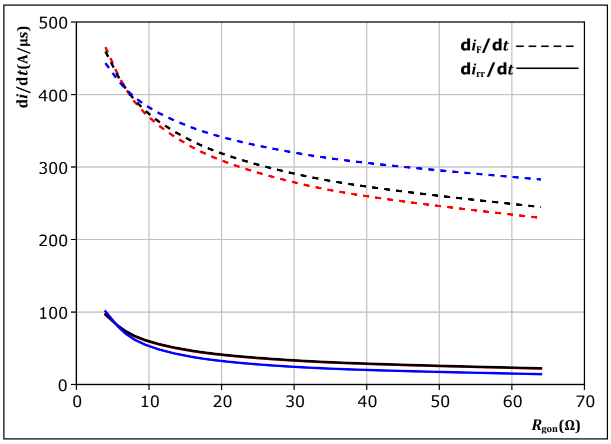
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
R_{gon} =	32	Ω		150 °C

figure 49. **FWD**

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

di_F/dt, di_{rr}/dt = f(R_{gon})



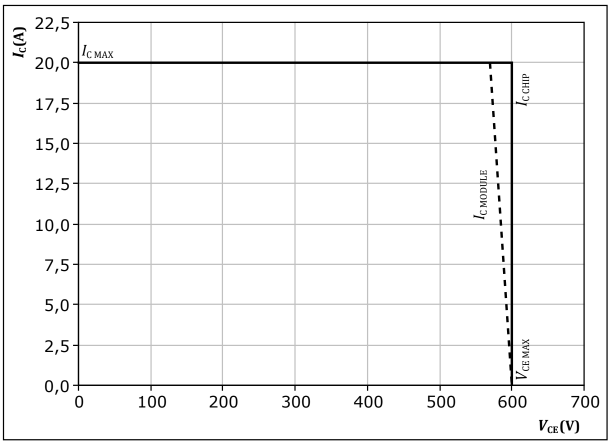
With an inductive load at

V_{CE} =	300	V	T_j:	25 °C
V_{GE} =	0/15	V		125 °C
I_C =	10	A		150 °C

figure 50. **IGBT**

Reverse bias safe operating area

I_C = f(V_{CE})



At	T_j =	150	°C
	R_{gon} =	32	Ω
	R_{goff} =	16	Ω

Switching Definitions

figure 51. IGBT

Turn-off Switching Waveforms & definition of t_{doff}, t_{Eoff} (t_{tEoff} = integrating time for E_{off})

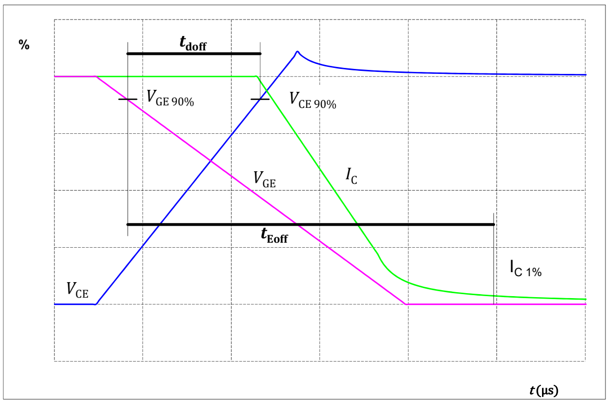


figure 52. IGBT

Turn-on Switching Waveforms & definition of t_{don}, t_{Eon} (t_{Eon} = integrating time for E_{on})

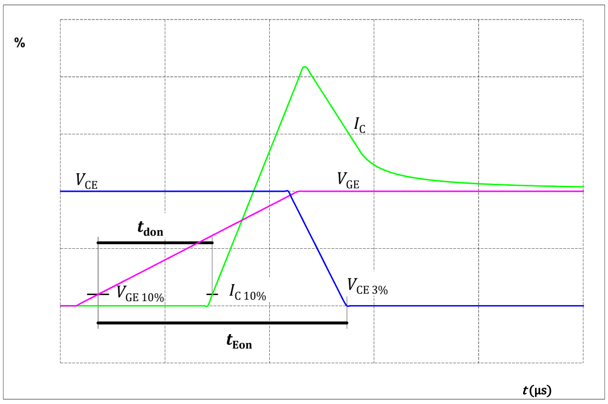


figure 53. IGBT

Turn-off Switching Waveforms & definition of t_f

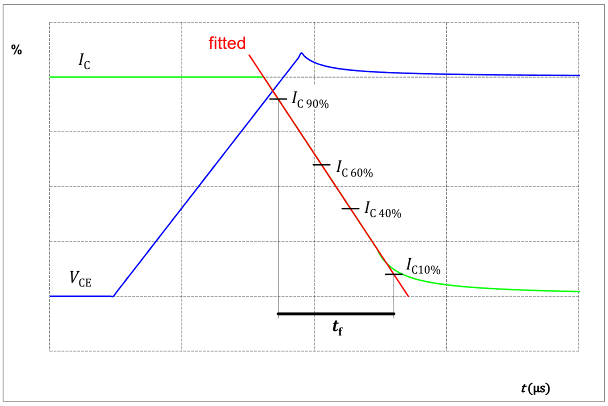
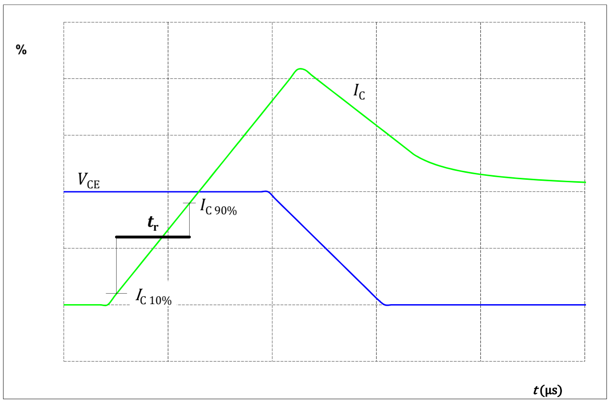


figure 54. IGBT

Turn-on Switching Waveforms & definition of t_r



Switching Definitions

figure 55.	FWD

Turn-off Switching Waveforms & definition of t_{rr}

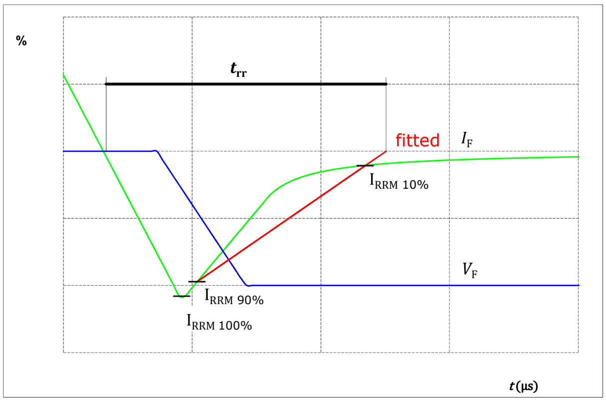
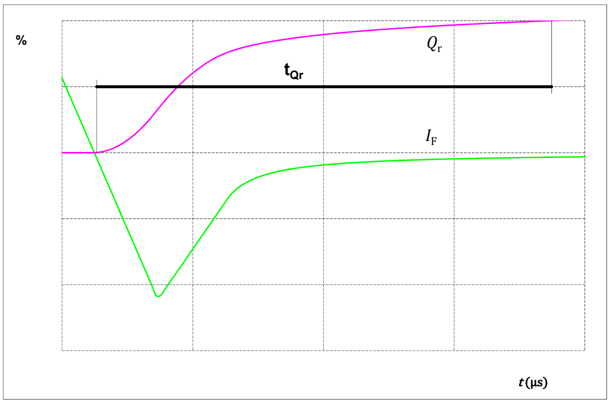


figure 56.	FWD

Turn-on Switching Waveforms & definition of t_{Qr} **(**t_{Qr} **= integrating time for** Q_r**)**



V23990-P544-A29-PM
datasheet

Ordering Code

Version	Ordering Code
Without thermal paste	V23990-P544-A29-PM
With thermal paste (5,2 W/mK, PTM6000HV)	V23990-P544-A29-/7/-PM
With thermal paste (3,4 W/mK, PSX-P7)	V23990-P544-A29-/3/-PM

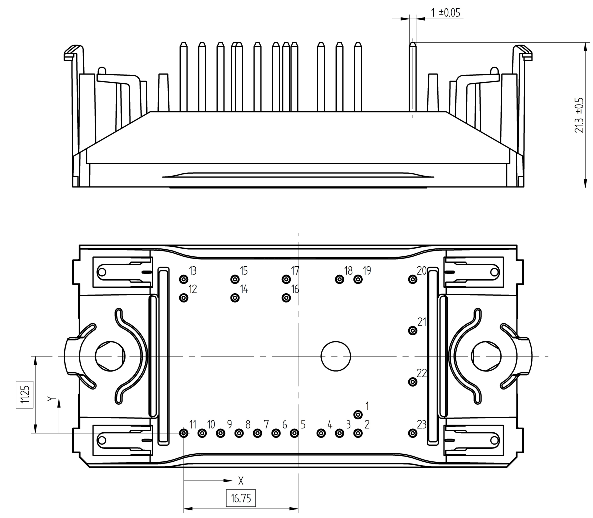
Marking

Text	**VIN**	**Date code**	**Type&Ver**	**UL**	**Lot**	**Serial**
	VIN	WWYY	TTTTTTTVV	UL	LLLLL	SSSS
Datamatrix	**Type&Ver**	**Lot number**	**Serial**	**Date code**		
	TTTTTTTVV	LLLLL	SSSS	WWYY		

Outline

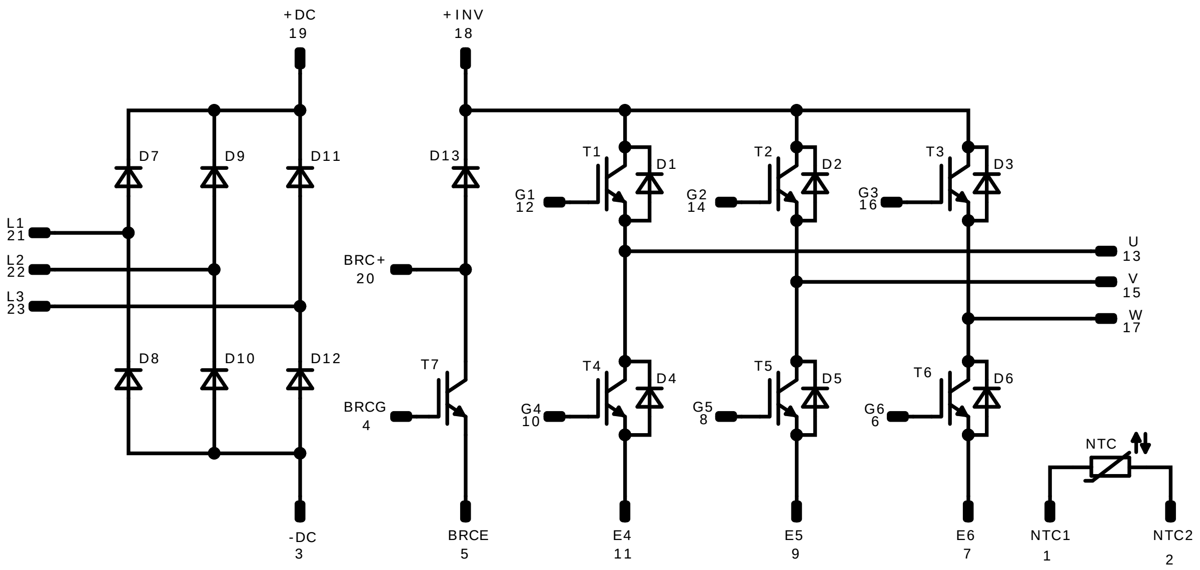
Pin table [mm]

Pin	X	Y	Function
1	25,5	2,7	NTC1
2	25,5	0	NTC2
3	22,8	0	-DC
4	20,1	0	BRCG
5	16,2	0	BRCE
6	13,5	0	G6
7	10,8	0	E6
8	8,1	0	G5
9	5,4	0	E5
10	2,7	0	G4
11	0	0	E4
12	0	19,8	G1
13	0	22,5	U
14	7,5	19,8	G2
15	7,5	22,5	V
16	15	19,8	G3
17	15	22,5	W
18	22,8	22,5	+INV
19	25,5	22,5	+DC
20	33,5	22,5	BRC+
21	33,5	15	L1
22	33,5	7,5	L2
23	33,5	0	L3



Tolerance of pinpositions: ±0.5mm at the end of pins
Dimension of coordinate axis is only offset without tolerance

Pinout



Identification

ID	Component	Voltage	Current	Function	Comment
T2, T1, T5, T2, T6, T3	IGBT	600 V	15 A	Inverter Switch	
D1, D4, D2, D5, D3, D6	FWD	600 V	15 A	Inverter Diode	
T7	IGBT	600 V	10 A	Brake Switch	
D13	FWD	600 V	10 A	Brake Diode	
D8, D7, D10, D9, D12, D11	Rectifier	1600 V	25 A	Rectifier Diode	
NTC	NTC			Thermistor	

Packaging instruction				
Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for *flow* 0 packages see vincotech.com website.

Package data
Package data for *flow* 0 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.

Document No.:	Date:	Modification:	Pages
V23990-P544-A29-PM-D9-14	6 May. 2022	New Datasheet format, module is unchanged Updated dynamic and thermal characteristic	